TOSHIBA

TOSHIBA Photocoupler GaAs Ired & Photo-Triac

TLP160J

Triac Drive Programmable Controllers AC-Output Module Solid State Relay

The TOSHIBA mini flat coupler TLP160J is a small outline coupler, suitable for surface mount assembly. The TLP160J consists of a photo triac, optically coupled to a gallium arsenide infrared emitting diode.

- Peak off-state voltage: 600 V (min.)
- Trigger LED current: 10 mA (max.)
- On-state current: 70 mA (max.)
- Isolation voltage: 2500 Vrms (min.)
- UL recognized: UL1577, file No. E67349

Trigger LED Current

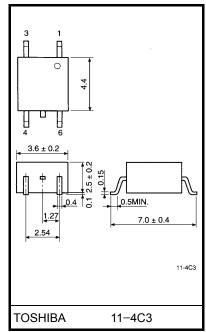
Classi– fication*	Trigger LED C	Marking Of Classification	
	V _T =6V, Ta		
	Min.	Max.	Classification
(IFT7)	—	7	Τ7
Standard	_	10	T7, blank

*Ex. (IFT7); TLP160J (IFT7)

(Note) Application type name for certification test, please

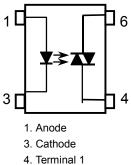
use standard product type name, i.e.

TLP160J (IFT7): TLP160J



Weight: 0.09 g (typ.)

Pin Configurations



6. Terminal 2

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit	
LED	Forward current	١ _F	50	mA		
	Forward current derating (T	ΔI _F / °C	-0.7	mA / °C		
	Peak forward current (100 µ	I _{FP}	1	А		
	Reverse voltage	V _R	5	V		
	Junction temperature	Tj	125	°C		
	Off-state output terminal vo	V _{DRM}	600	V		
	On-state RMS current	Ta=25°C		70	mA	
		Ta=70°C	I _{T(RMS)}	40	IIIA	
Detector	On-state current derating (ΔI _T / °C	-0.67	mA / °C		
Dete	Peak on-state current (100	I _{TP}	2	Α		
	Peak nonrepetitive surge cu (PW=10ms)	ITSM	1.2	А		
	Junction temperature	Tj	115	°C		
Storage temperature range			T _{stg}	–55 to 125	°C	
Operating temperature range			T _{opr}	-40 to 100	°C	
Lead soldering temperature (10 s)			T _{sol}	260	°C	
Isolation voltage (AC, 1 min., R.H. \leq 60%) (Note)			BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{AC}			240	Vac
Forward current	١ _F	15	20	25	mA
Peak on-state current	I _{TP}	-	-	1	А
Operating temperature	T _{opr}	-25		85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

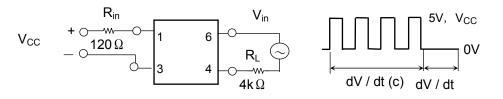
Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	30	_	pF
Detector	Peak off-state current	I _{DRM}	V _{DRM} = 600 V	_	10	1000	nA
	Peak on-state voltage	V _{TM}	I _{TM} = 70 mA	-	1.7	2.8	V
	Holding current	Ι _Η	—	_	1.0	_	mA
	Critical rate of rise of off-state voltage	dv / dt	V _{in} = 240 Vrms, Ta = 85°C (Fig.1)	_	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	I _T = 15 mA, V _{in} = 60 Vrms (Fig.1)		0.2	_	V / µs

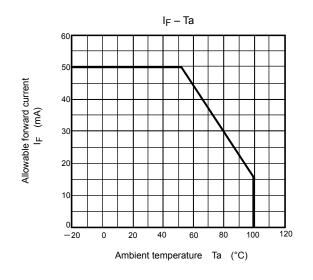
Coupled Electrical Characteristics (Ta = 25°C)

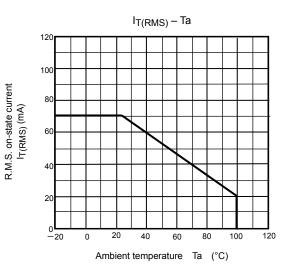
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Trigger LED current	I _{FT}	V _T = 6 V	_	5	10	mA
Capacitance input to output	CS	V _S = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	1×10 ¹²	10 ¹⁴	_	Ω
		AC, 1 minute	2500	_	_	Vrms
Isolation voltage	BVS	AC, 1 second, in oil		5000	_	
		DC, 1 minute, in oil	_	5000	_	Vdc
Turn–on time	t _{ON}	$V_D = 6 \rightarrow 4V, R_L = 100\Omega$ I _F = rated I _{FT} × 1.5	_	30	100	μs

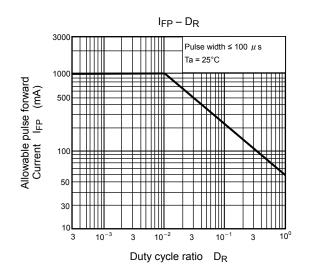
Fig.1 dv / dt test circuit

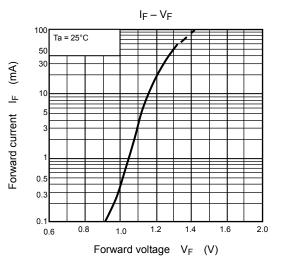


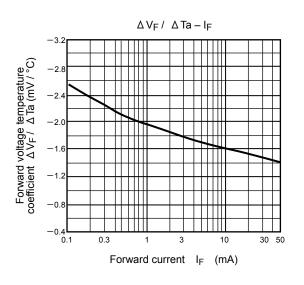
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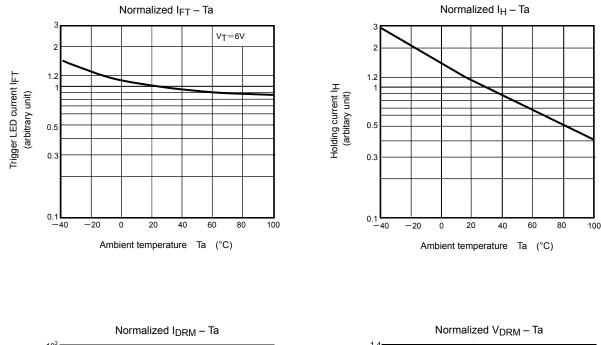


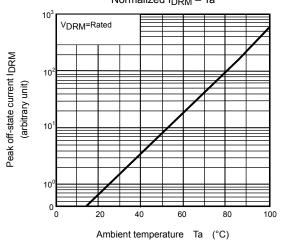


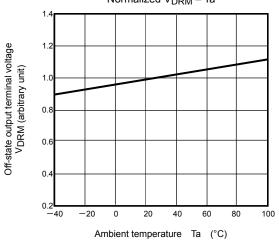
IFP - VFP 1000 500 300 100 50 30 10 Pulse width ≤ 10 µs Repetitive frequency = 100 Hz Ta = 25°C 1 0.6 1.4 1.8 2.2 2.6 3.0 1.0 Pulse forward voltage V_{FP} (V)

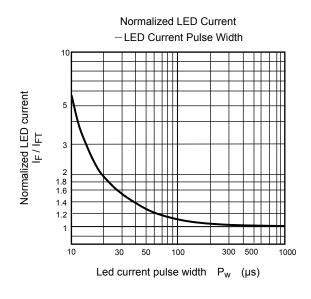
IFP (mA)

Pulse forward current









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